# TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 ETAS ID: TM756122

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	SECURITY INTEREST
SEQUENCE:	1

### **CONVEYING PARTY DATA**

Name	Formerly	Execution Date	Entity Type
SPAN.IO, INC.		09/19/2022	Corporation: DELAWARE

### **RECEIVING PARTY DATA**

Name:	Silicon Valley Bank
Street Address:	387 Park Avenue South, 2nd Floor
City:	New York
State/Country:	NEW YORK
Postal Code:	10016
Entity Type:	Corporation: CALIFORNIA

### **PROPERTY NUMBERS Total: 9**

Property Type	Number	Word Mark
Serial Number:	90902129	POWERED BY SPAN
Registration Number:	6575067	SPAN
Registration Number:	6594492	SPAN
Serial Number:	97036123	SPAN DRIVE
Registration Number:	6594493	SPAN HOME
Registration Number:	6594494	SPAN INSTALLER
Serial Number:	90482315	SPAN PLATFORM
Serial Number:	97036133	SPAN POWERASSIST
Serial Number:	97490972	SPAN POWERUP

## **CORRESPONDENCE DATA**

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 8004945225

**Email:** ipteam@cogencyglobal.com

Correspondent Name: JAY DASILVA

Address Line 1: 1025 CONNECTICUT AVE., NW, STE. 712

Address Line 2: COGENCY GLOBAL INC.

Address Line 4: WASHINGTON, D.C. 20036

TRADEMARK REEL: 007853 FRAME: 0297

900720861

ATTORNEY DOCKET NUMBER:	1787857 TM A
NAME OF SUBMITTER:	Naomi Sakata
SIGNATURE:	/Naomi Sakata/
DATE SIGNED:	09/19/2022
Total Attachments: 8	
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## INTELLECTUAL PROPERTY SECURITY AGREEMENT

This Intellectual Property Security Agreement (this "Agreement") is entered into as of September 19, 2022 by and between **SILICON VALLEY BANK**, a California corporation, with a loan production office located at 387 Park Avenue South, 2<sup>nd</sup> Floor, New York, New York 10016 ("Bank") and **SPAN.IO**, **INC.**, a Delaware corporation with its principal place of business located at 679 Bryant Street, San Francisco, California 94107 ("Grantor").

### **RECITALS**

- A. Bank has agreed to make certain advances of money and to extend certain financial accommodations to Grantor (the "Loans") in the amounts and manner set forth in that certain Second Amended and Restated Loan and Security Agreement by and between Bank and Grantor dated as of September 19, 2022 (as the same may be amended, modified or supplemented from time to time, the "Loan Agreement"; capitalized terms used herein are used as defined in the Loan Agreement). Bank is willing to make the Loans to Grantor, but only upon the condition, among others, that Grantor shall grant to Bank a security interest in its Copyrights, Trademarks, Patents, and Mask Works (as each term is described below) to secure the obligations of Grantor to Bank.
- B. Pursuant to the terms of the Loan Agreement, Grantor has granted to Bank a security interest in all of Grantor's right, title and interest, whether presently existing or hereafter acquired, in, to and under all of the Collateral.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, and intending to be legally bound, as collateral security for the prompt and complete payment when due of Grantor's obligations to Bank, Grantor hereby represents, warrants, covenants and agrees as follows:

#### AGREEMENT

- 1. <u>Grant of Security Interest</u>. To secure Grantor's obligations to Bank, Grantor grants and pledges to Bank a security interest in all of Grantor's right, title and interest in, to and under its intellectual property (all of which shall collectively be called the "Intellectual Property Collateral"), including, without limitation, the following:
- (a) Any and all copyright rights, copyright applications, copyright registrations and like protections in each work of authorship and derivative work thereof, whether published or unpublished and whether or not the same also constitutes a trade secret, now or hereafter existing, created, acquired or held, including without limitation those set forth on Exhibit A attached hereto (collectively, the "Copyrights");
- (b) Any and all trade secrets, and any and all intellectual property rights in computer software and computer software products now or hereafter existing, created, acquired or held;
- (c) Any and all design rights that may be available to Grantor now or hereafter existing, created, acquired or held;

- (d) All patents, patent applications and like protections including, without limitation, improvements, divisions, continuations, renewals, reissues, extensions and continuations-in-part of the same, including without limitation the patents and patent applications set forth on Exhibit B attached hereto (collectively, the "Patents");
- (e) Any trademark and servicemark rights, whether registered or not, applications to register and registrations of the same and like protections, and the entire goodwill of the business of Grantor connected with and symbolized by such trademarks, including without limitation those set forth on <u>Exhibit C</u> attached hereto (collectively, the "Trademarks");
- (f) All mask works or similar rights available for the protection of semiconductor chips, now owned or hereafter acquired, including, without limitation those set forth on Exhibit D attached hereto (collectively, the "Mask Works");
- (g) Any and all claims for damages by way of past, present and future infringements of any of the rights included above, with the right, but not the obligation, to sue for and collect such damages for said use or infringement of the intellectual property rights identified above;
- (h) All licenses or other rights to use any of the Copyrights, Patents, Trademarks, or Mask Works and all license fees and royalties arising from such use to the extent permitted by such license or rights;
- (i) All amendments, extensions, renewals and extensions of any of the Copyrights, Trademarks, Patents, or Mask Works; and
- (j) All proceeds and products of the foregoing, including without limitation all payments under insurance or any indemnity or warranty payable in respect of any of the foregoing.

Notwithstanding anything to the contrary herein, the Intellectual Property Collateral shall not include any United States intent-to-use trademark or service mark applications filed pursuant to Section 1(b) of the Lanham Act, 15 U.S.C. § 1051, at all times prior to the filing of a "Statement of Use" pursuant to Section 1(d) of the Lanham Act or an "Amendment to Allege Use" pursuant to Section 1(c) of the Lanham Act with respect thereto with the United States Patent and Trademark Office or otherwise.

- 2. <u>Recordation</u>. Grantor authorizes the Commissioner for Patents, the Commissioner for Trademarks and the Register of Copyrights and any other government officials to record and register this Agreement upon request by Bank.
- 3. <u>Authorization</u>. Grantor hereby authorizes Bank to (a) modify this Agreement unilaterally by amending the exhibits to this Agreement to include any Intellectual Property Collateral which Grantor obtains subsequent to the date of this Agreement, and (b) file a duplicate original of this Agreement containing amended exhibits reflecting such new Intellectual Property Collateral.

- 4. <u>Loan Documents</u>. This Agreement has been entered into pursuant to and in conjunction with the Loan Agreement, which is hereby incorporated by reference. The provisions of the Loan Agreement shall supersede and control over any conflicting or inconsistent provision herein. The rights and remedies of Bank with respect to the Intellectual Property Collateral are as provided by the Loan Agreement and related documents, and nothing in this Agreement shall be deemed to limit such rights and remedies.
- 5. <u>Execution in Counterparts</u>. This Agreement may be executed in counterparts (and by different parties hereto in different counterparts), each of which shall constitute an original, but all of which when taken together shall constitute a single contract. Delivery of an executed counterpart of a signature page to this Agreement by facsimile or in electronic (i.e., "pdf" or "tif" format) shall be effective as delivery of a manually executed counterpart of this Agreement.
- 6. <u>Successors and Assigns</u>. This Agreement will be binding on and shall inure to the benefit of the parties hereto and their respective successors and assigns.
- 7. Governing Law. This Agreement and any claim, controversy, dispute or cause of action (whether in contract or tort or otherwise) based upon, arising out of or relating to this Agreement and the transactions contemplated hereby and thereby shall be governed by, and construed in accordance with, the laws of the United States and the State of New York, without giving effect to any choice or conflict of law provision or rule (whether of the State of New York or any other jurisdiction) except for Sections 5-1401 and 5-1402 of the New York General Obligations Law.

[Signature page follows.]

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IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed as of the first date written above.

GRANTOR:

SPAN.IO, INC.

By: Ardian Rao

Name: Archan Rao

Title: Chief Executive Officer

BANK:

SILICON VALLEY BANK

By: 5BE7B2CEREC74E6

Name: Jackson Morrow Title: Vice President

## EXHIBIT A

Copyrights

Description

Registration/ Application Number Registration/ Application <u>Date</u>

NONE

ny-1365681

## EXHIBIT B

## Patents

Description	Registration/ Application Number	Registration/ Application <u>Date</u>
INTEGRATED ELECTRICAL PANEL	11342754	Issued: 05/24/2022
INTEGRATED ELECTRICAL MANAGEMENT SYSTEM AND ARCHITECTURE	16593899	Filed: 10/04/2019
SYSTEMS AND METHODS FOR MANAGING ELECTRICAL LOADS	17024073	Filed: 09/17/2020
MULTILAYER CONTROL FOR MANAGING POWER FLOW	17570803	Filed: 01/07/2022
INTEGRATED ELECTRICAL PANEL	17689350	Filed: 03/08/2022

ny-1365681

## EXHIBIT C

## Trademarks

Description	Registration/ Application Number	Registration/ Application <u>Date</u>
POWERED BY SPAN	AN: 90902129	Filed: August 25, 2021
SPAN (Stylized)	RN: 6575067 AN: 90482299	Filed: January 22, 2021 Registered: November 30, 2021
SPAN	RN: 6594492 AN: 90482282	Filed: January 22, 2021 Registered: December 21, 2021
SPAN DRIVE	AN: 97036123	Filed: September 20, 2021
SPAN HOME	RN: 6594493 AN: 90482306	Filed: January 22, 2021 Registered: December 21, 2021
SPAN INSTALLER	RN: 6594494 AN: 90482310	Filed: January 22, 2021 Registered: December 21, 2021
SPAN PLATFORM	AN: 90482315	Filed: January 22, 2021
SPAN POWERASSIST	AN: 97036133	Filed: September 20, 2021
SPAN POWERUP	AN: 97490972	Filed: July 6, 2022

EXHIBIT D

Mask Works

Description

Registration/ Application Number Registration/ Application <u>Date</u>

NONE

TRADEMARK REEL: 007853 FRAME: 0306

RECORDED: 09/19/2022